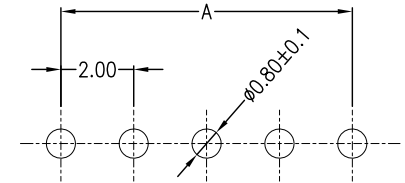


REV	DESCRIPTION	DESIGN	DATE
A	NEW RELEASE	Lingqing	2021/06/02

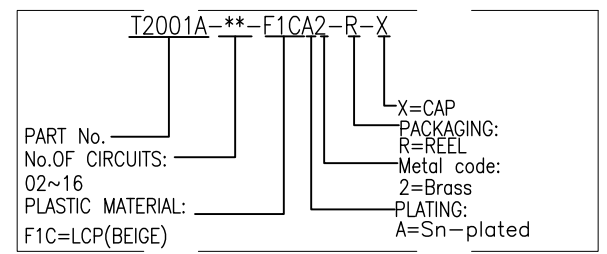
Specifications:  
 Contact resistance:  $\leq 20m\Omega$   
 Insulation resistance:  $\geq 1000M\Omega$   
 Rated voltage: 250V AC DC  
 Rated current: 2.0A AC DC  
 Withstand voltage: 1000V AC/minute  
 Temperature range:  $-25^{\circ}C \sim +105^{\circ}C$   
 Housing: LCP UL94V-0, Natural  
 Cap: LCP UL94V-0, Natural  
 Contacts: Brass/Sn-plated

Circuits	Dimensions (mm)			
	A	B	C	D
02	2.00	4.90	6.00	1.00
03	4.00	6.90	8.00	2.00
04	6.00	8.90	10.00	4.00
05	8.00	10.90	12.00	6.00
06	10.00	12.90	14.00	6.00
07	12.00	14.90	16.00	6.00
08	14.00	16.90	18.00	6.00
09	16.00	18.90	20.00	6.00
10	18.00	20.90	22.00	6.00
11	20.00	22.90	24.00	6.00
12	22.00	24.90	26.00	6.00
13	24.00	26.90	28.00	6.00
14	26.00	28.90	30.00	6.00
15	28.00	30.90	32.00	6.00
16	30.00	32.90	34.00	6.00

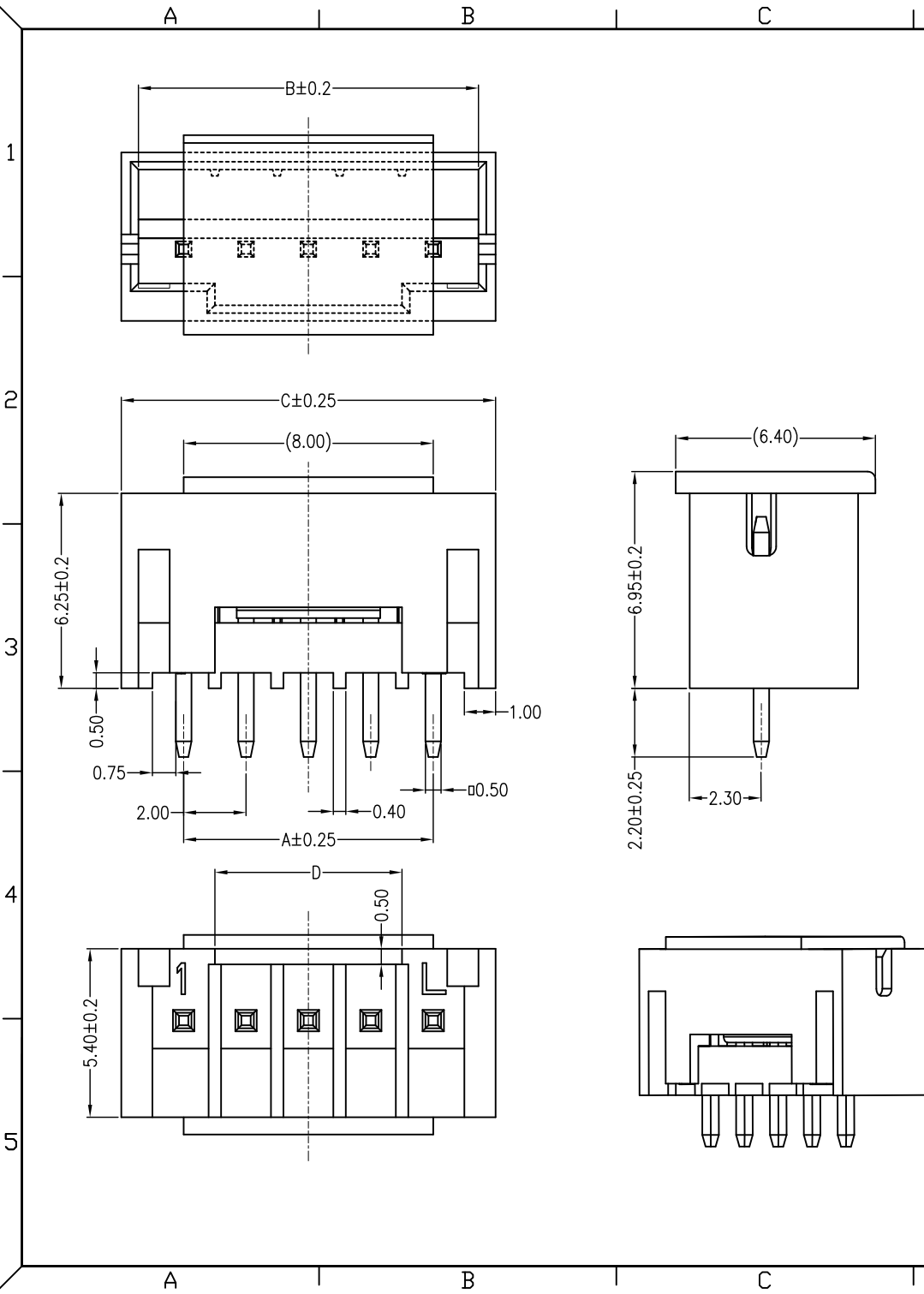


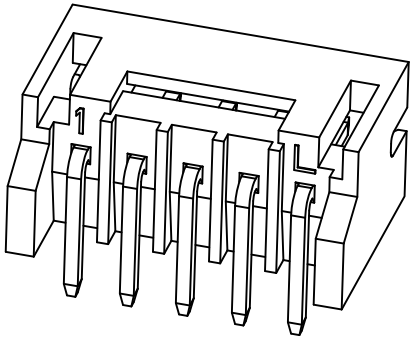
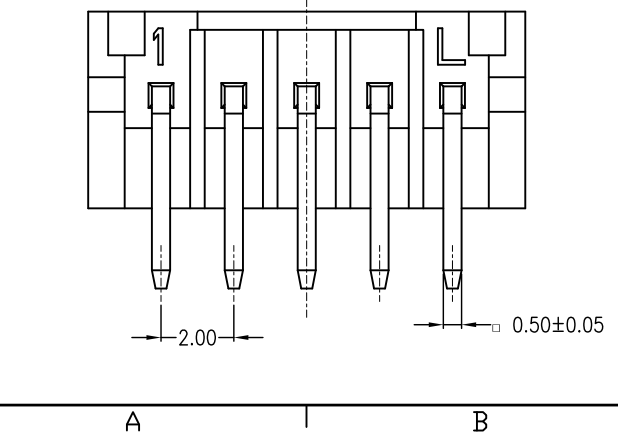
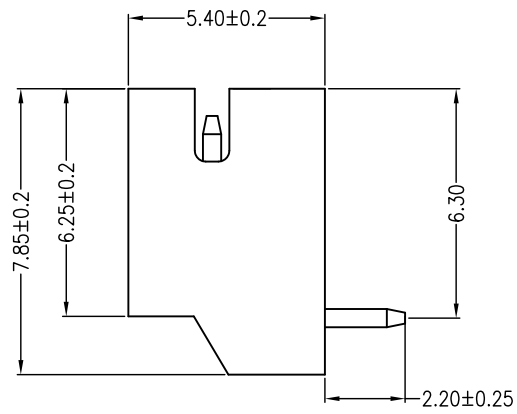
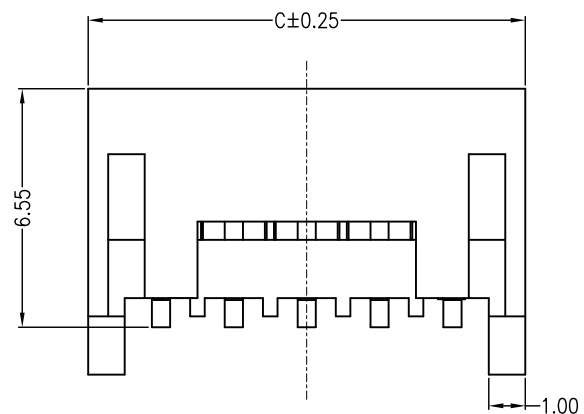
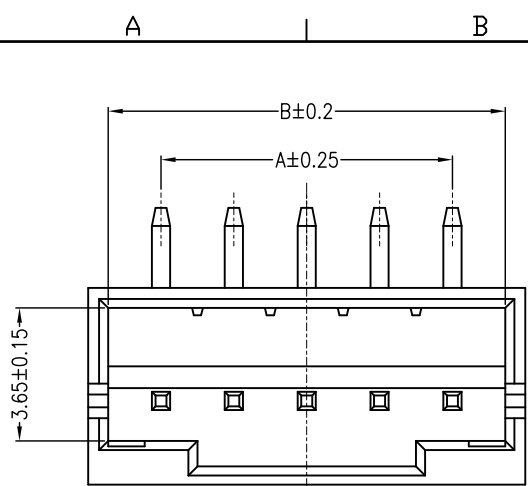
RECOMMENDED PCB LAYOUT(TOP VIEW)  
 TOLERANCE:  $\pm 0.05mm$

ORDER INFORMATION:



<b>東莞市高迪電子有限公司</b> DONG GUAN GAO DI ELECTRONICS CO., LTD		TITLE: 2.00mm pitch 180°Wafer DIP type	
		PART NO.: T2001A-**-F1CA2-R-X	
GENERAL TOLERANCE		APPD: Shaojinghe	
X. $\pm 0.50$	X. $\pm 5^{\circ}$	CHKD: Fangsongle	
X.X $\pm 0.30$	X.X $\pm 2^{\circ}$	DR: Zenglingqing	
X.XX $\pm 0.20$	X.XX $\pm 1^{\circ}$	SCALE: 1 : 1	
UNITS: mm		SHEET: 1 / 1	

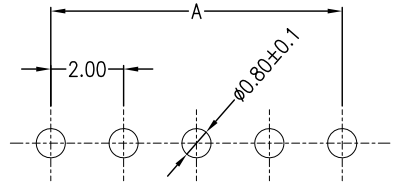




Circuits	Dimensions (mm)		
	A	B	C
02	2.00	4.90	6.00
03	4.00	6.90	8.00
04	6.00	8.90	10.00
05	8.00	10.90	12.00
06	10.00	12.90	14.00
07	12.00	14.90	16.00
08	14.00	16.90	18.00
09	16.00	18.90	20.00
10	18.00	20.90	22.00
11	20.00	22.90	24.00
12	22.00	24.90	26.00
13	24.00	26.90	28.00
14	26.00	28.90	30.00
15	28.00	30.90	32.00
16	30.00	32.90	34.00

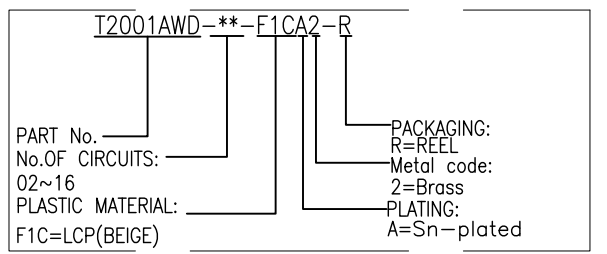
REV	DESCRIPTION	DESIGN	DATE
A	NEW RELEASE	Lingqing	2021/06/02

**Specifications:**  
 Contact resistance: ≤20mΩ  
 Insulation resistance: ≥1000MΩ  
 Rated voltage: 250V AC DC  
 Rated current: 2.0A AC DC  
 Withstand voltage: 1000V AC/minute  
 Temperature range: -25°C ~ +105°C  
 Housing: LCP UL94V-0, Natural  
 Contacts: Brass/Sn-plated



RECOMMENDED PCB LAYOUT (TOP VIEW)  
 TOLERANCE: ±0.05mm

ORDER INFORMATION:

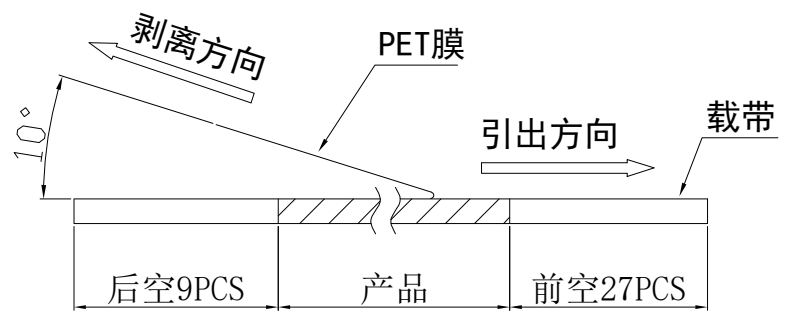
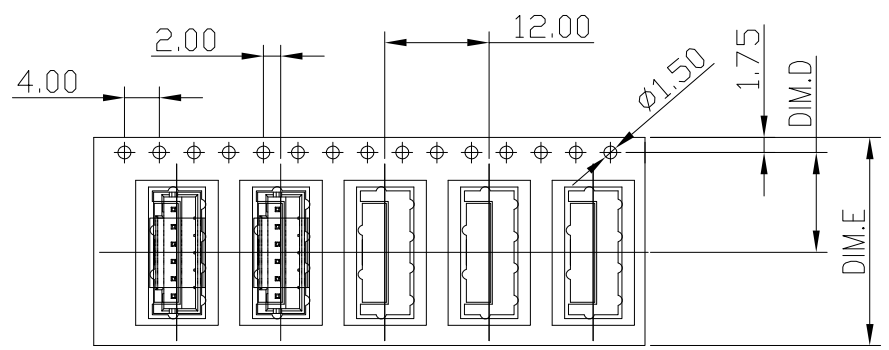


**東莞市高迪電子有限公司**  
 DONG GUAN GAO DI ELECTRONICS CO., LTD

GENERAL TOLERANCE		USE:
X. ±0.50	X. ±5'	CUSTOMER
X.X ±0.30	X.X ±2'	APPD: Shaojinghe
X.XX ±0.20	X.XX ±1'	CHKD: Fangsongle
UNITS: mm		DR: Zenglingqing

TITLE: 2.00mm pitch 90°Wafe PIP type	
PART NO.:	
T2001AWD-**-F1CA2-R	
DWG NO.:	
GCKH-0927	
SCALE 1 : 1	SHEET 1 / 1

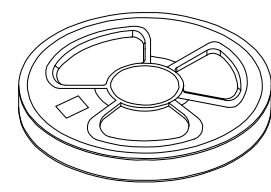
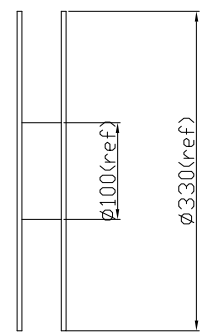
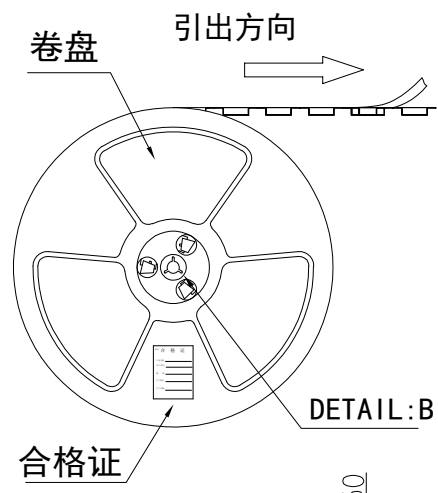
REV	ECN No.	DESCRIPTION	DESIGN	DATE
A		Release	程永海	2022.11.14



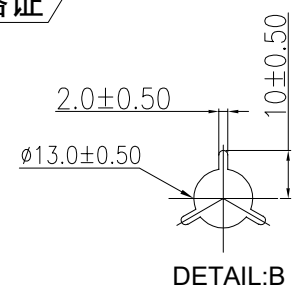
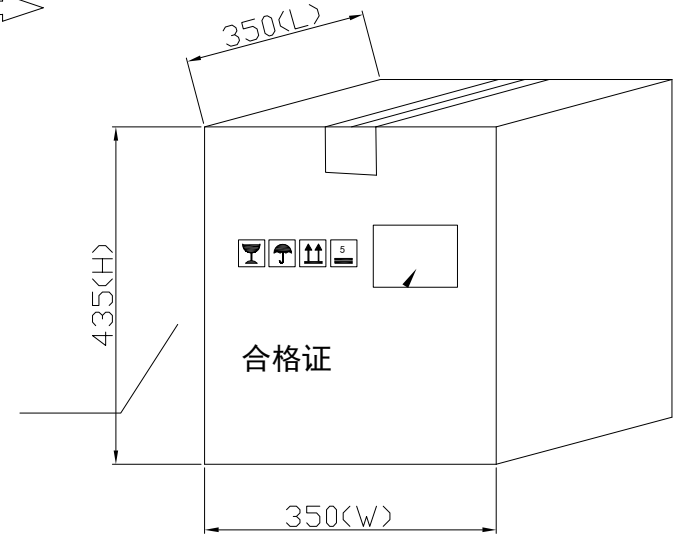
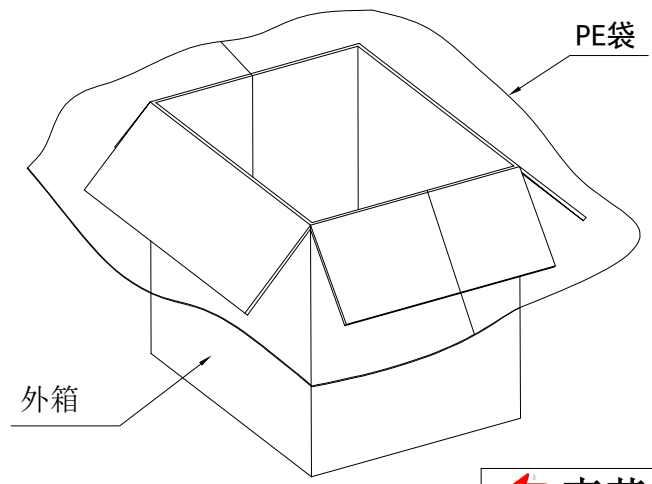
02~06 CONTACTS

产品引出方向

(PET膜剥离示意图)



装\*盘(参考列表一)



列表一

Circuits	DIM. D	DIM. E	Q'ty/Reel	Packing (Reel/Caton)
02-03 PIN	7.5	16	500PCS	20/Reel
04-06 PIN	11.5	24	500PCS	15/Reel

包装说明:

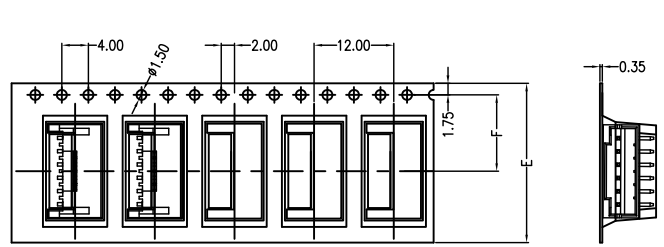
- 把成品包入卷盘中, 每盘装500PCS, 卷盘上贴上合格证, 将装好产品的卷盘放进外箱中, 外箱内先套一个大PE袋, 外箱上贴贴上合格证.
- 所有材料有害物控制需符合RoHS标准.

**东莞市高迪电子有限公司**  
DONG GUAN GAO DI ELECTRONICS CO., LTD

X.± 0.5	X.±'	USE: MANUFACTURE
.X±0.3	.X±'	
.XX±0.25	.XX±'	
--	--	APPD: 朱志刚
		CHKD: 蒋建银
UNITS: mm		DR: 程永海

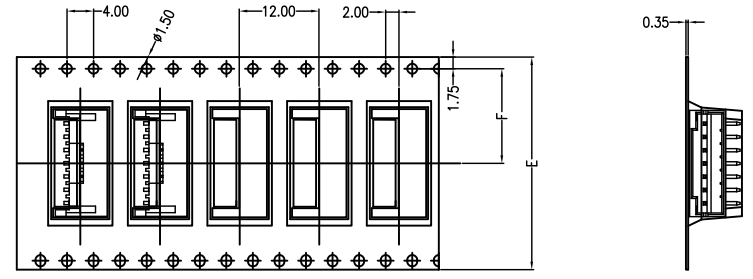
TITLE: T2001A	
PART NO.: T2001A包装规范	
DWG NO.: GCKH-0926	
SCALE: 1:1	SHEET: 1/1

REV	ECN No.	DESCRIPTION	DESIGN	DATE
A		Release	陈志明	2022.01.19



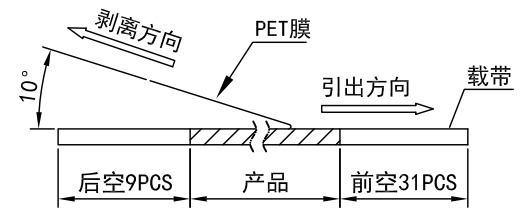
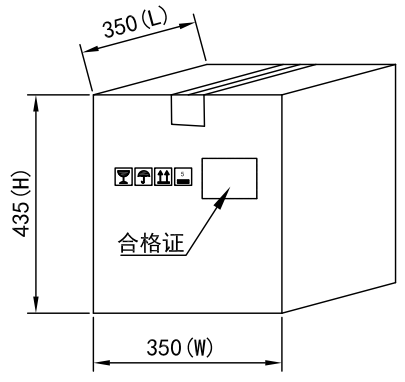
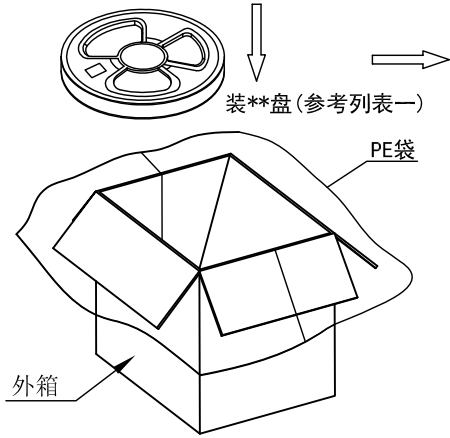
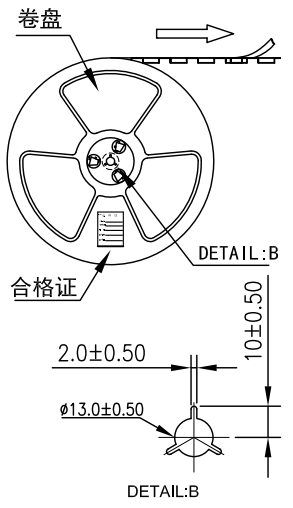
02~06 CONTACTS

引出方向



07~08 CONTACTS

引出方向



(PET膜剥离示意图)

列表一

Circuits	DIM. E	DIM. F	Q'ty/Reel	Packing (Reel/Caton)
02~03PIN	16.00	7.50	600PCS	20/Reel
04~06PIN	24.00	11.50	600PCS	15/Reel
07~08PIN	32.00	14.25	600PCS	11/Reel

包装说明:

- 把成品包入卷盘中, 每盘装600PCS, 卷盘上贴上合格证, 将装好产品的卷盘放进外箱中, 外箱内先套一个大PE袋, 外箱上贴贴上合格证.
- 所有材料有害物控制需符合RoHS标准.

东莞市高迪电子有限公司  
DONG GUAN GAO DI ELECTRONICS CO., LTD

X.± 0.5	X.±'	USE: CUSTOMER
.X± 0.3	.X±'	APPD: 张忠永
.XX±0.25	.XX±'	CHKD: 蒋建银
--	--	DR: 陈志明
		UNITS: mm

TITLE:
PART NO.: T2001AWD 卷装规范
DWG NO.: JKUN/GCBZ-0927
SCALE: 1 : 1
SHEET: 1 / 1